MOSFET – P-Channel, Logic Level, POWERTRENCH[®]

FDS4435A

General Description

This P-Channel Logic Level MOSFET is produced using ON Semiconductor's advanced POWERTRENCH process that has been especially tailored to minimize the on-state resistance and yet maintain low gate charge superior switching performance.

These devices are well suited for notebook computer applications: load switching and power management, battery charging circuits, and DC/DC conversion.

Features

- -9 A, -30 V. $R_{DS(ON)} = 0.017 \Omega$ @ $V_{GS} = -10 V$ $R_{DS(ON)} = 0.025 \Omega$ @ $V_{GS} = -4.5 V$
- Low Gate Charge (21 nC Typical).
- High Performance Trench Technology for Extremely Low RDS(ON)
- High Power and Current Handling Capability
- This Device is Pb-Free and RoHS Compliant

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^{\circ}C$ unless otherwise noted)

Symbol	Parameter	Ratings	Unit
V _{DS}	Drain-Source Voltage	-30	V
V _{GSS}	Gate-Source Voltage	±20	V
Ι _D	Drain Current – Continuous (Note 1a) – Pulsed	_9 _50	A
PD	Power Dissipation (Note 1a) for Single Operation (Note 1b) (Note 1c)	2.5 1.2 1	W
T _J , T _{STG}	Operating and Storage Junction Temperature Range	-55 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

Symbol	Parameter	Ratings	Unit
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient (Note 1a)	50	°C/W
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case (Note 1)	25	°C/W

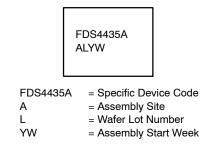


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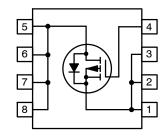
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ELECTRICAL CONNECTION



ORDERING INFORMATION

See detailed ordering and shipping information on page $\,5$ of this data sheet.

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ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Symbol	Parameter	Test Condition	Min	Тур	Max	Unit		
OFF CHARACTERISTICS								
BV _{DSS}	Drain-Source Breakdown Voltage	V_{GS} = 0 V, I_D = –250 μA	-30	-	-	V		
$\frac{\Delta \text{BV}_{\text{DSS}}}{\Delta \text{T}_{\text{J}}}$	Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu$ A, Referenced to 25°C	-	-26	-	mV/°C		
I _{DSS}	Zero Gate Voltage Drain Current	V_{DS} = -24 V, V_{GS} = 0 V	-	-	-1	μΑ		
		$T_{J} = 125^{\circ}C$	-	-	-10			
I _{GSSF}	Gate-Body Leakage Current, Forward	V_{GS} = -20 V, V_{DS} = 0 V	-	-	-100	nA		
I _{GSSR}	Gate-Body Leakage Current, Reverse	V_{GS} = 20 V, V_{DS} = 0 V	-	-	100	nA		

ON CHARACTERISTICS

V _{GS(th)}	Gate Threshold Voltage	V_{DS} = V_{GS} , I_D = -250 μ A		-1	-1.7	-2	V
$\Delta V_{GS(th)}$	Gate Threshold Voltage Temperature Coefficient	I_D = -250 µA, Referenced to 25°C		-	4.2	-	mV/°C
ΔT_{J}							
R _{DS(on)}	Static Drain-Source On-Resistance	$V_{GS} = -10$ V, $I_{D} = -9$ A		-	0.015	0.017	Ω
		-	T _J = 125°C	-	0.021	0.030	
		V_{GS} = -4.5 V, I _D = -7 A		-	0.023	0.025	
9 _{FS}	Forward Transconductance	$V_{DS} = -10 \text{ V}, \text{ I}_{D} = -9 \text{ A}$		-	25	-	S

DYNAMIC CHARACTERISTICS

C _{iss}	Input Capacitance	V _{DS} = –15 V, V _{GS} = 0 V f = 1.0 MHz	-	2010	_	pF
C _{oss}	Output Capacitance		-	590	_	pF
C _{rss}	Reverse Transfer Capacitance		-	260	-	pF

SWITCHING CHARACTERISTICS

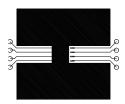
t _{d(on)}	Turn-On Delay Time	V_{DD} = -15 V, I _D = -1 A V _{GS} = -10 V, R _{GEN} = 6 Ω	-	12	22	ns
t _r	Turn-On Rise Time	$V_{GS} = -10$ V, $H_{GEN} = 0.52$	-	15	27	ns
t _{d(off)}	Turn-Off Delay Time		-	100	140	ns
t _f	Turn-Off Fall Time		-	55	80	ns
Qg	Total Gate Charge	V _{DS} = -15 V, I _D = -9 A V _{GS} = -5 V	-	21	30	nC
Q _{gs}	Gate-Source Charge	$V_{GS} = -5 V$	-	6	-	nC
Q _{gd}	Gate-Drain Charge]	-	8	-	nC

DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS

۱ _S	Maximum Continuous Drain-Source Diode Forward Current		-	-	-2.1	Α
V _{SD}	Drain–Source Diode Forward Voltage $V_{GS} = 0 V$, $I_S = -2.1 A$ (Note 2)		-	-0.75	-1.2	V
t _{rr}	Source-Drain Reverse Recovery Time	$I_F = -10 \text{ A}, dI_F/dt = 100 A/\mu S$	-	36	80	ns

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

1. R_{0JA} is the sum of the junction-to-case and case-to-ambient resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta,C}$ is guaranteed by design while $R_{\theta,CA}$ is determined by the user's board design.



a) 50°C/W when mounted on a 1 in² pad of 2 oz. Copper.



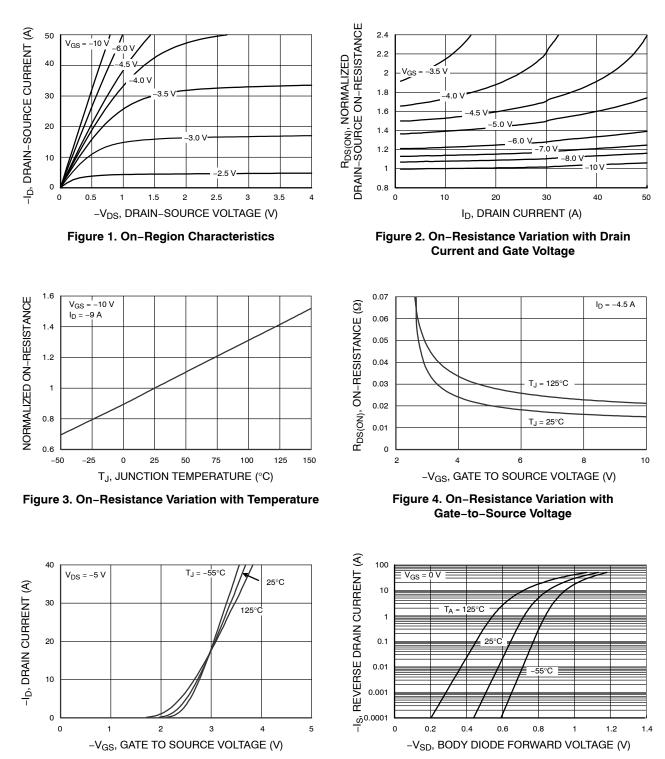


b) 105°C/W when mounted on a 0.04 in² pad of 2 oz. copper.

2. Pulse Test Pulse Width \leq 300 μ s, Duty Cycle \leq 2.0%

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TYPICAL CHARACTERISTICS



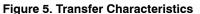
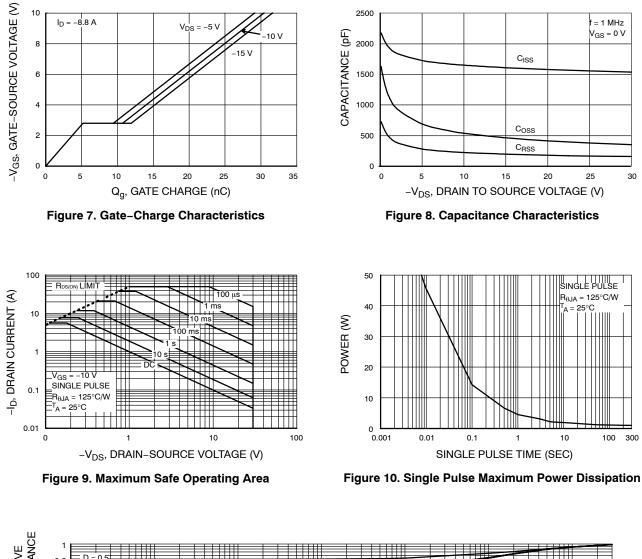
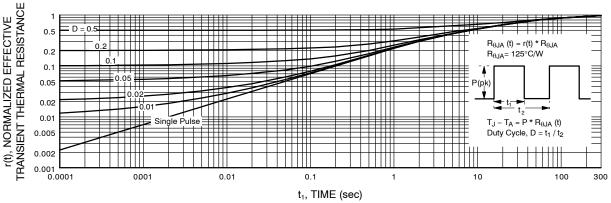


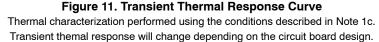
Figure 6. Body Diode Forward Voltage Variation with Source Current and Temperature

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TYPICAL CHARACTERISTICS (continued)







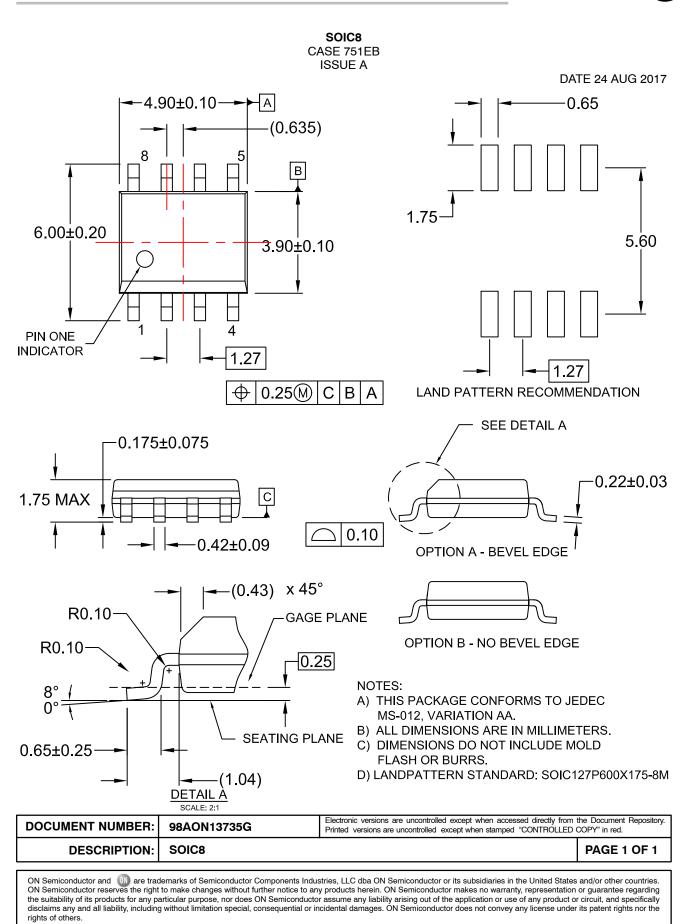
ORDERING INFORMATION

Device Marking	Device	Package Type	Reel Size	Tape Width	Shipping [†]
FDS4435A	FDS4435A	SOIC8 (Pb-Free)	13"	12 mm	2500 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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